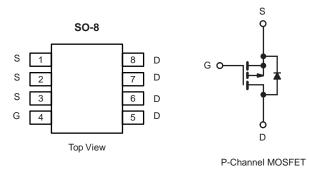


## FDS4425-NL-VB Datasheet P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
- 30	0.011 at V <sub>GS</sub> = - 10 V	- 11.6	22 nC			
- 30	0.012 at V <sub>GS</sub> = - 4.5 V	- 10	22110			



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % Rg Tested
- 100 % UIS Tested

#### **APPLICATIONS**

- Load Switches
- Notebook PCs
  - Desktop PCs



COMPLIANT HALOGEN

FREE Available

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 30	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		- 11.6		
Continuous Drain Current (T = $150$ °C)	T <sub>C</sub> = 70 °C		- 10.5		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C		- 8.7 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 7.7 <sup>a, b</sup>	•	
Pulsed Drain Current	I <sub>DM</sub>	- 40	— A		
Continuous Courses Drain Diada Current	T <sub>C</sub> = 25 °C		- 4.6		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	2.0 <sup>a, b</sup>		
Avalanche Current	1 0.1 ml l	I <sub>AS</sub>	- 20		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		5.6		
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C	ъ	3.6	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	vv	
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	39	50	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	18	22	C/W	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

c. Maximum under Steady State conditions is 85 °C/W. d. Based on  $T_C = 25$  °C.

b. t = 10 s.

<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 30			V		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 31				
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			5.5		mV/°C		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 3.0	V		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA		
Zana Cata Maltana Drain Comrant	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1			
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 5	μΑ		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ - 10 V, $V_{GS}$ = - 10 V	- 30			А		
Drain Course On Ctate Desister of	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A	0.011			Ω		
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 7 A		0.012				
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 10 A		23		S		
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>			1960				
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		380		pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	ss		325				
Total Gate Charge	0	$V_{DS}$ = - 15 V, $V_{GS}$ = - 10 V, $I_D$ = - 10 A		43	65	65		
Iolai Gale Charge	· ·	$Q_g$		22	33	nC		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 15 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 10 A		6				
Gate-Drain Charge	Q <sub>gd</sub>			11				
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.3	1.3	2.5	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			11	22			
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 3 $\Omega$		13	25			
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 5 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		32	50			
Fall Time	t <sub>f</sub>			9	18	ns		
Turn-On Delay Time	t <sub>d(on)</sub>			44	70	115		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 3 $\Omega$		100	160			
Turn-Off DelayTime	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 5 A, $\text{V}_\text{GEN}$ = - 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		28	50			
Fall Time	t <sub>f</sub>			15	30			
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.6	А		
Pulse Diode Forward Current	I <sub>SM</sub>				- 50	~		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.75	- 1.2	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>			28	45	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 2 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		20	40	nC		
Reverse Recovery Fall Time	t <sub>a</sub>	$F = 2 \Lambda$ , $a_1a_1 = 100 \Lambda/\mu s$ , $f_1 = 25 C$		13		ns		
Reverse Recovery Rise Time	t <sub>b</sub>			15		113		

Notes:

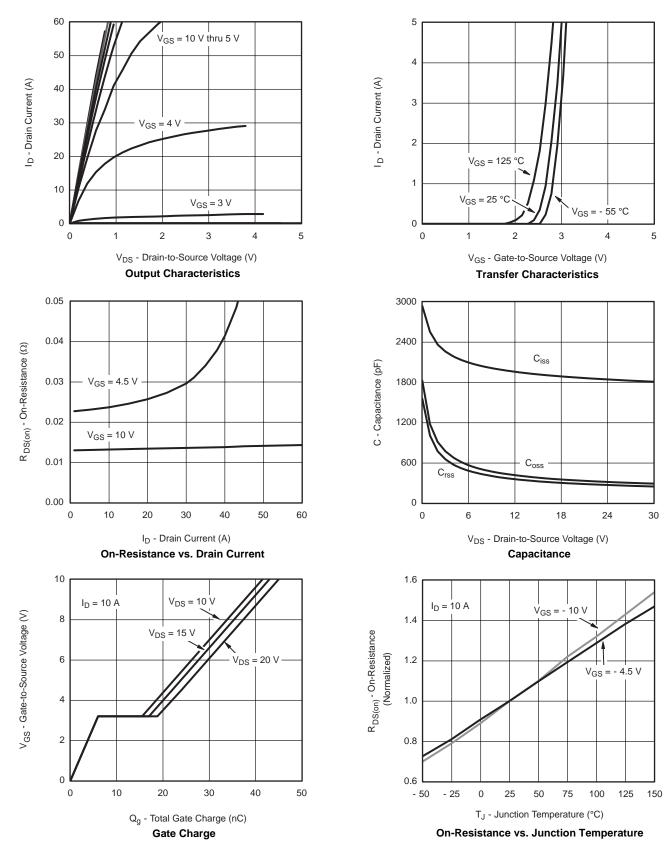
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

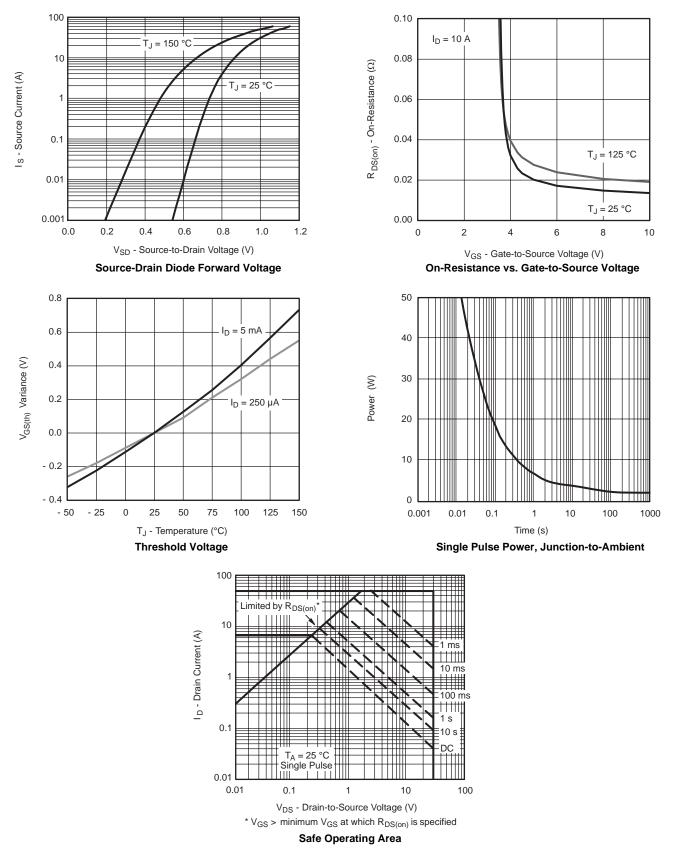
Bsemi VBsemi.com



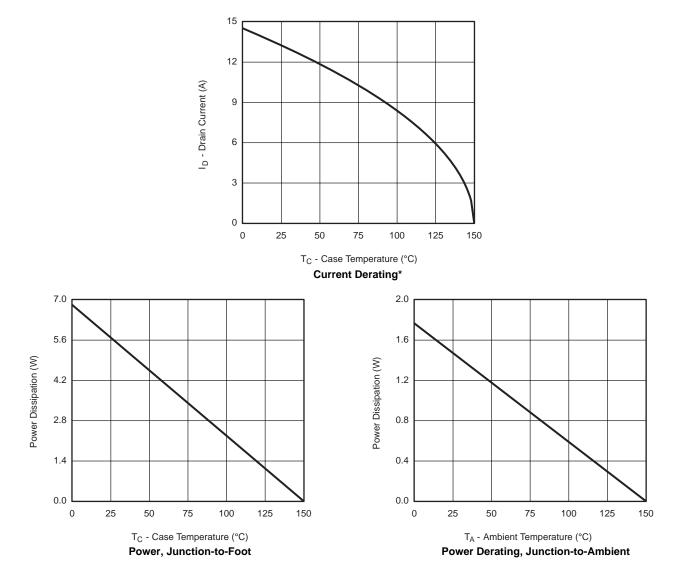


服务热线:400-655-8788



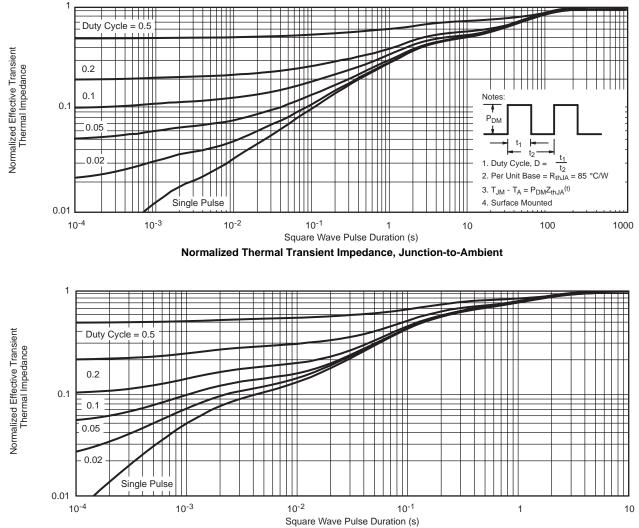






\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Foot



### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





	MILLIM	MILLIMETERS		INCHES		
DIM	Min	Max	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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